TE Internal #: 2110957-2

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 8 Gb/s, Internal/External EMI Springs, SFP, Not Optional, 1 x 6, Through

Hole - Press-Fit, 6 Port

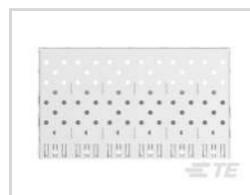
View on TE.com >



Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+











Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 8 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: SFP Lightpipe Options: Not Optional

Termination Post & Tail Length

Features

Product Type Features

Form Factor	SFP
Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Lightpipe Options	Not Optional
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Port Matrix Configuration	1 x 6
Number of Ports	6
Electrical Characteristics	
Data Rate (Max)	8 Gb/s
Termination Features	

2.05 mm[.081 in]



Termination Method to Printed Circuit Board	Through Hole - Press-Fit
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Mechanical Attachment

Housing Features

Cage Material	Nickel Silver Alloy
Sage Material	THERET STIVET 7 THEY

Dimensions

PCB Thickness (Recommended)	1.5 mm
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Usage Conditions

Operating Temperature Range -55 – 85 °C[-67 –	185 °F]
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Operation/Application

For Use With Pluggable I/O Products	SFF -8436 Compatible Transceiver
Pluggable I/O Applications	SFP
Circuit Application	Signal

Industry Standards

UL Flammability Rating	UL 94V-0	

Packaging Features

Packaging Method	Tray	

Other

EMI Containment Feature Type	Internal/External EMI Springs
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought



Documents

Product Drawings
SFP 1X6 CAGE ASSY, PRESS FIT

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2110957-2_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2110957-2_A.3d_igs.zip

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 8 Gb/s, Internal/External EMI Springs, SFP, Not Optional, 1 x 6, Through Hole - Press-Fit, 6 Port



English

Customer View Model

ENG_CVM_CVM_2110957-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English